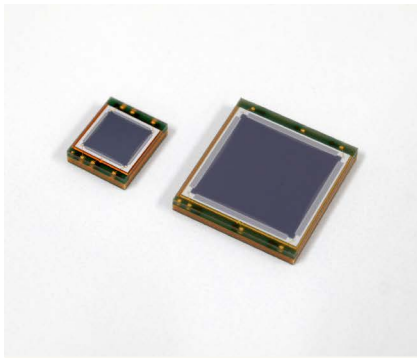


# Two-dimensional PSD



S15534

**NEW**  
S15535

## Surface mount type, high-accuracy position sensitive detector

The S15534 and S15535 are surface mount type two-dimensional PSDs with excellent position detection characteristics. They are smaller than the conventional S5990-01.

### Features

- Surface mount type
- Excellent position detectability
- Small package
- Compatible with lead-free solder reflow

### Applications

- Light spot detection
- Pointing device
- Various types of position detection

### Structure

Parameter	Symbol	S15534	S15535 <b>NEW</b>	Unit
Photosensitive area	A	4 × 4	9 × 9	mm
Package	-	Glass epoxy		-
Window material	-	Silicone resin		-

### Absolute maximum ratings

Parameter	Symbol	Value	Unit
Reverse voltage	V <sub>R max</sub>	20	V
Operating temperature* <sup>1</sup>	T <sub>opr</sub>	-20 to +60	°C
Storage temperature* <sup>1</sup>	T <sub>stg</sub>	-20 to +80	°C
Soldering temperature	T <sub>sol</sub>	260 (3 times)* <sup>2</sup>	°C

\*1: No dew condensation. When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

\*2: Reflow soldering, JEDEC J-STD-020 MSL 3, see P.8 (S15534)  
Reflow soldering, JEDEC J-STD-020 MSL 4, see P.8 (S15535)

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

### Electrical and optical characteristics (Ta=25 °C)

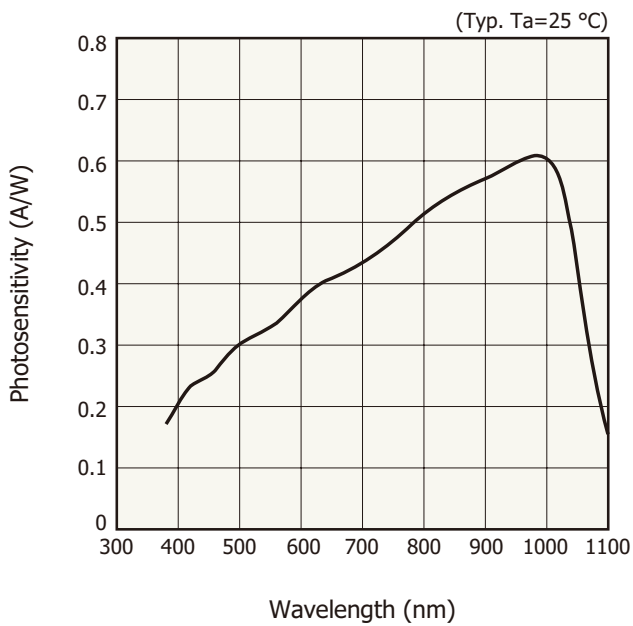
Parameter	Symbol	Condition	S15534			S15535 <b>NEW</b>			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Spectral response range	$\lambda$		-	380 to 1100	-	-	380 to 1100	-	nm
Peak sensitivity wavelength	$\lambda_p$		-	980	-	-	980	-	nm
Photosensitivity	S	$\lambda=\lambda_p$	-	0.6	-	-	0.6	-	A/W
Interelectrode resistance	Rie	Vb=0.1 V	5	7	15	5	7	15	k $\Omega$
Position detection error*3	E		-	$\pm 70$	$\pm 150$	-	$\pm 150$	$\pm 250$	$\mu\text{m}$
Saturation photocurrent	Ist	$\lambda=900\text{ nm}$ , VR=5 V RL=1 k $\Omega$	-	500	-	-	500	-	$\mu\text{A}$
Dark current	ID	VR=5 V	-	0.5	10	-	1	50	nA
Rise time	tr	VR=5 V, RL=1 k $\Omega$ $\lambda=900\text{ nm}$ , 10 % to 90 %	-	1	-	-	2	-	$\mu\text{s}$
Terminal capacitance	Ct	VR=5 V, f=10 kHz	-	70	-	-	350	-	pF
Position resolution	$\Delta R$	I $\bar{o}$ =1 $\mu\text{A}$ , B=1 kHz*4	-	0.7	-	-	1.5	-	$\mu\text{m}$

\*3:  $\lambda=900\text{ nm}$  VR=5 V, light spot:  $\phi 0.2\text{ mm}^{\ast 4}$  (S15534)

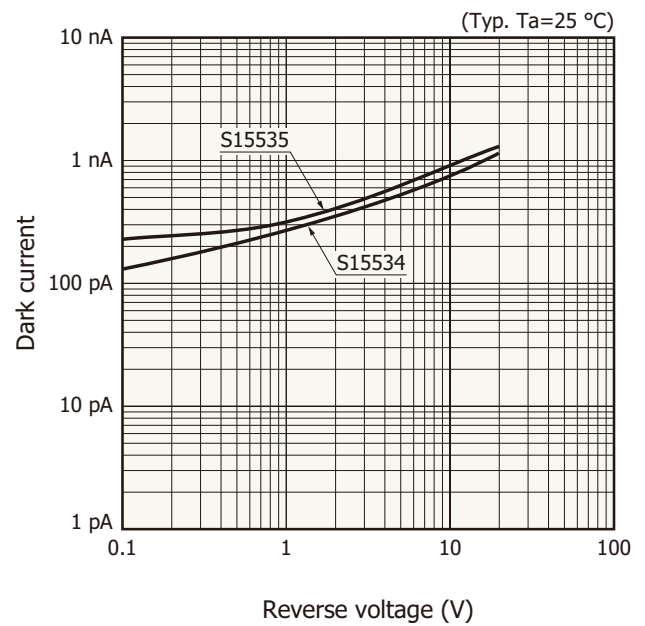
$\lambda=830\text{ nm}$  VR=5 V, light spot:  $\phi 0.2\text{ mm}^{\ast 4}$  (S15535)

\*4: Specified within a circle that is 80 % of the photosensitive area. Recommended light spot size:  $\phi 0.2\text{ mm}$  or more

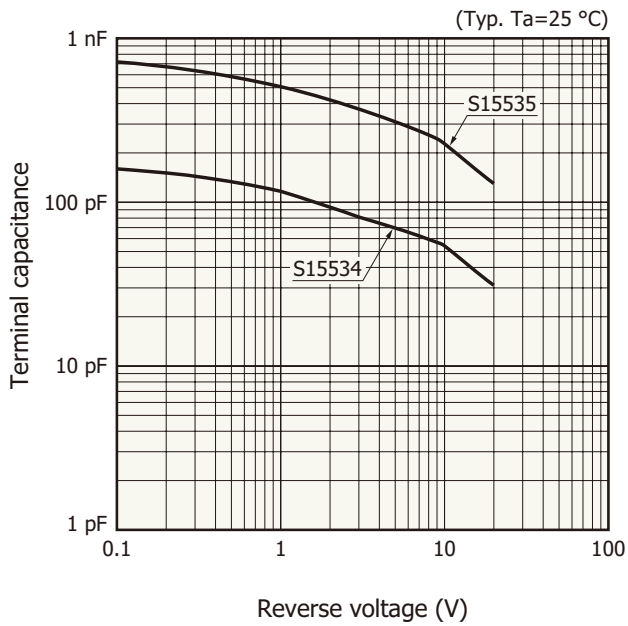
### Spectral response



### Dark current vs. reverse voltage



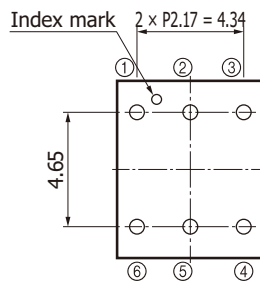
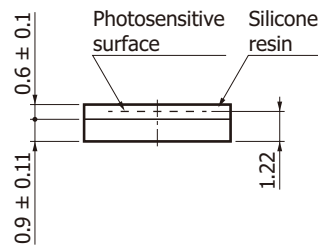
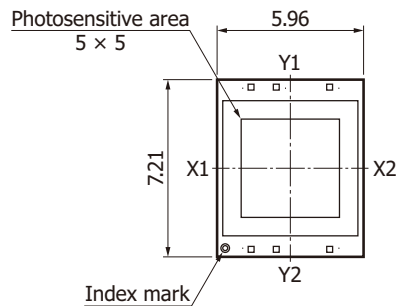
Terminal capacitance vs. reverse voltage



KPSDB0130EB

Dimensional outlines (unit: mm)

S15534

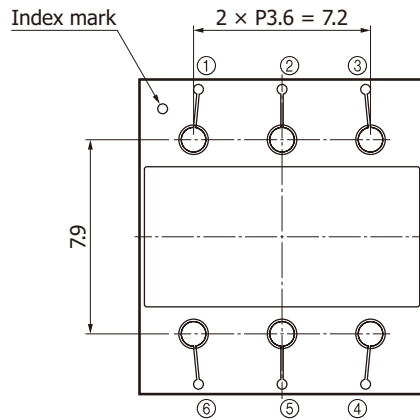
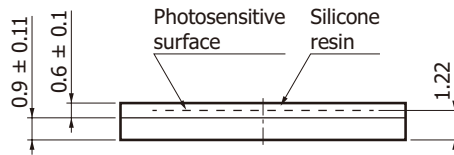
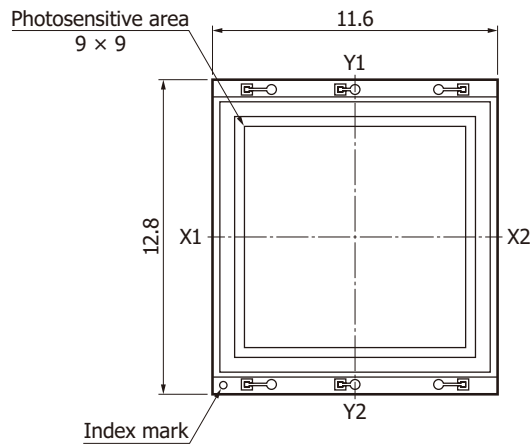


Tolerance unless otherwise noted:  $\pm 0.15$   
Chip position accuracy with respect to package center X, Y  $\leq \pm 0.1$

- ① Anode X1
- ② Cathode (common)
- ③ Anode Y1
- ④ Anode X2
- ⑤ NC
- ⑥ Anode Y2

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S15535



Tolerance unless otherwise noted:  $\pm 0.15$   
Chip position accuracy with respect to package center  
 $X, Y \leq \pm 0.1$

- ① Anode X1
- ② Cathode (common)
- ③ Anode Y1
- ④ Anode X2
- ⑤ NC
- ⑥ Anode Y2

KPSDA0069EA

**Conversion formula of spot light position on the PSD**

Output signals (photocurrent)  $I_{X1}$ ,  $I_{X2}$ ,  $I_{Y1}$ ,  $I_{Y2}$  obtained from electrodes and the light spot position  $x$ ,  $y$  can be found by the following formula.

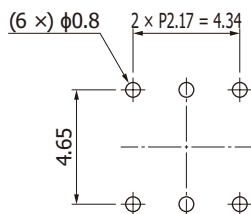
$$\frac{(I_{X2} + I_{Y1}) - (I_{X1} + I_{Y2})}{I_{X1} + I_{X2} + I_{Y1} + I_{Y2}} = \frac{2x}{L_X}$$

$$\frac{(I_{X2} + I_{Y2}) - (I_{X1} + I_{Y1})}{I_{X1} + I_{X2} + I_{Y1} + I_{Y2}} = \frac{2y}{L_Y}$$

- $I_{X1}$  : Output signal from electrode X1
- $I_{X2}$  : Output signal from electrode X2
- $I_{Y1}$  : Output signal from electrode Y1
- $I_{Y2}$  : Output signal from electrode Y2
- $x, y$  : Position coordinate of light spot
- $L_X, L_Y$ : Resistance length (S15534=4.5 mm, S15535=10 mm)

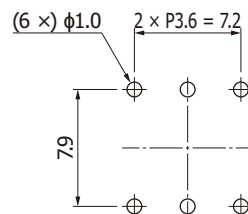
Recommended land pattern (unit: mm)

S15534



KP5DC0104EB

S15535

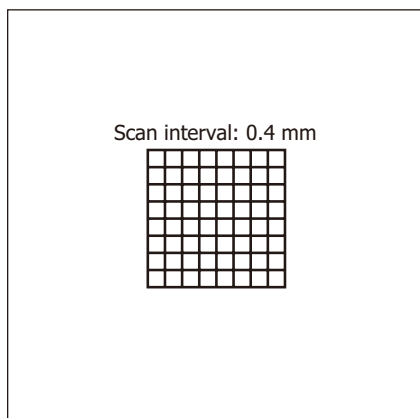


KP5DC0109EB

Example of position detectability

S15534

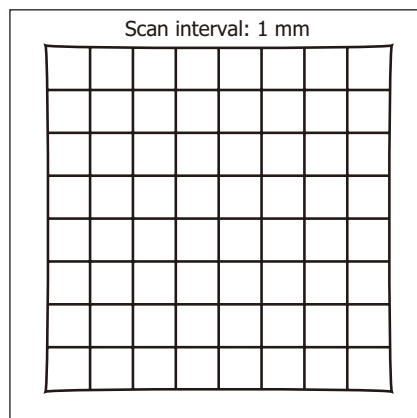
(Ta=25 °C, λ=900 nm, light spot size: φ0.2 mm)



KP5DC0064EA

S15535

(Ta=25 °C, λ=830 nm, light spot size: φ0.2 mm)



KP5DC0107EA

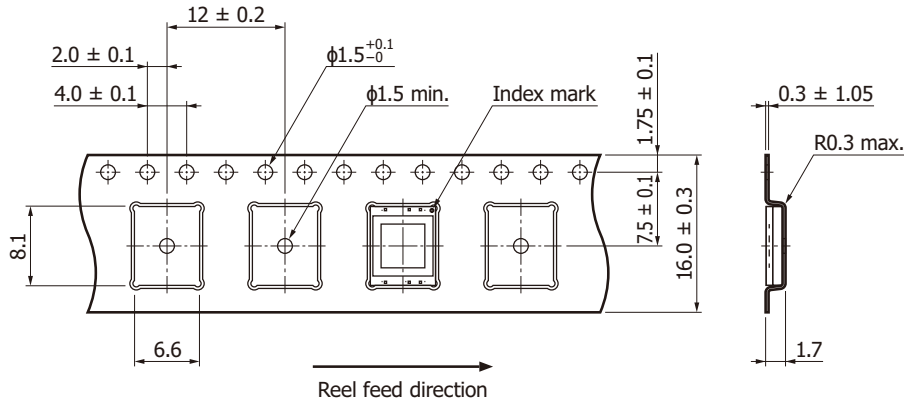
Standard packing specifications

S15534

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ330 mm	φ100 mm	16 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)



KP5DC0105EB

■ Packing quantity

500 pcs/reel

■ Packing state

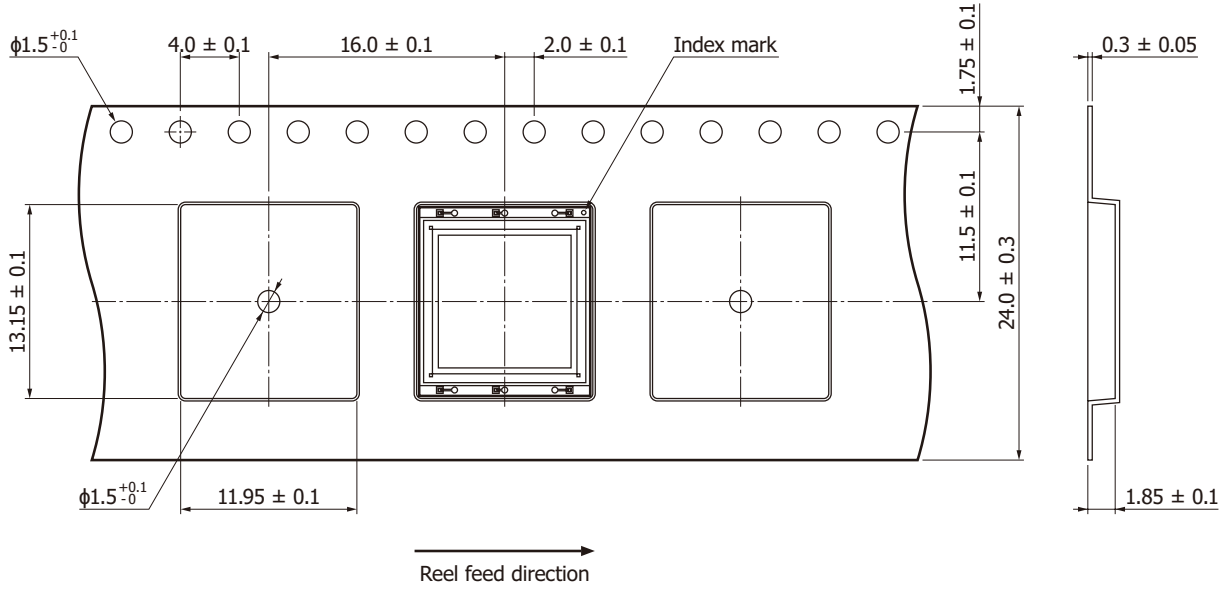
Reel and desiccant in moisture-proof packaging (vacuum-sealed)

S15535

- Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ330 mm	φ100 mm	24 mm	PS	Conductive

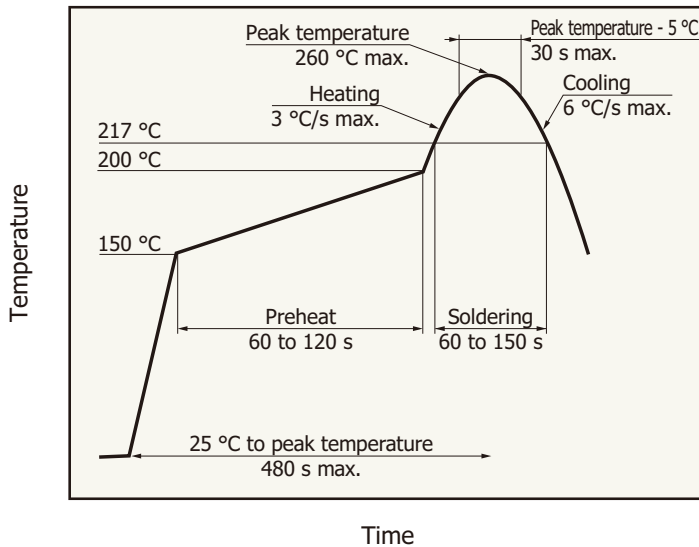
- Embossed tape (unit: mm, material: PS, conductive)



KSPDC0112EA

- Packing quantity  
100 pcs/reel
- Packing state  
Reel and desiccant in moisture-proof packaging (vacuum-sealed)

### Recommended reflow soldering conditions



KSPD00419EA

- After unpacking, store in an environment at a temperature of 5 to 30 °C and a humidity 60% or less, and perform reflow soldering within 168 hours.

Type no.	Storage period
S15534	168 hours
S15535	72 hours

- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

### Baking

If more than 12 months have passed in the unopened state, or storage conditions are exceeded after opening the package, baking is required to remove moisture before reflow soldering. For the baking, refer to "Precautions / Surface mount type products" in the related information.

#### Recommended baking conditions

Temperature: 150 °C (3 to 5 hours) or 120 °C (12 to 15 hours)

Note: Before setting the baking conditions, perform experiments to confirm that no problems occur with the product.

### Related information

[www.hamamatsu.com/sp/ssd/doc\\_en.html](http://www.hamamatsu.com/sp/ssd/doc_en.html)

#### Precautions

- Disclaimer
- Precautions / Surface mount type products

#### Catalogs

- Technical note / PSD

Information described in this material is current as of April 2026.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use. Copying or reprinting the contents described in this material in whole or in part is prohibited without our prior permission.